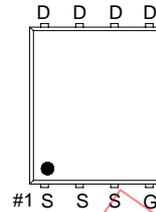
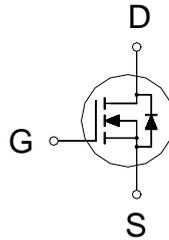


PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
30	8.5mΩ	20A



G : GATE
 D : DRAIN
 S : SOURCE

ABSOLUTE MAXIMUM RATINGS ($T_C = 25\text{ }^\circ\text{C}$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		V_{DS}	30	V
Gate-Source Voltage		V_{GS}	±20	V
Continuous Drain Current	$T_C = 25\text{ }^\circ\text{C}$	I_D	20	A
	$T_C = 70\text{ }^\circ\text{C}$		15	
Pulsed Drain Current ¹		I_{DM}	50	
Avalanche Current		I_{AR}	15	
Avalanche Energy	$L = 0.1\text{mH}$	E_{AS}	22.5	mJ
Repetitive Avalanche Energy ²	$L = 0.05\text{mH}$	E_{AR}	0.6	
Power Dissipation	$T_C = 25\text{ }^\circ\text{C}$	P_D	4.0	W
	$T_C = 70\text{ }^\circ\text{C}$		2.5	
Junction & Storage Temperature Range		T_j, T_{stg}	-55 to 150	$^\circ\text{C}$

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Ambient	$R_{\theta JA}$		31	$^\circ\text{C} / \text{W}$

¹Pulse width limited by maximum junction temperature.

²Duty cycle ≤ 1%

ELECTRICAL CHARACTERISTICS ($T_C = 25\text{ }^\circ\text{C}$, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0\text{V}, I_D = 250\mu\text{A}$	30			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	1	1.5	3.0	V
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0\text{V}, V_{GS} = \pm 20\text{V}$			±100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 24\text{V}, V_{GS} = 0\text{V}$			1	μA
		$V_{DS} = 20\text{V}, V_{GS} = 0\text{V}, T_J = 55\text{ }^\circ\text{C}$			10	
Drain-Source On-State Resistance ¹	$R_{DS(ON)}$	$V_{GS} = 5.0\text{V}, I_D = 14\text{A}$		9.5	13.5	$\text{m}\Omega$
		$V_{GS} = 10\text{V}, I_D = 17\text{A}$		7.2	8.5	
Forward Transconductance ¹	g_{fs}	$V_{DS} = 15\text{V}, I_D = 17\text{A}$		60		S

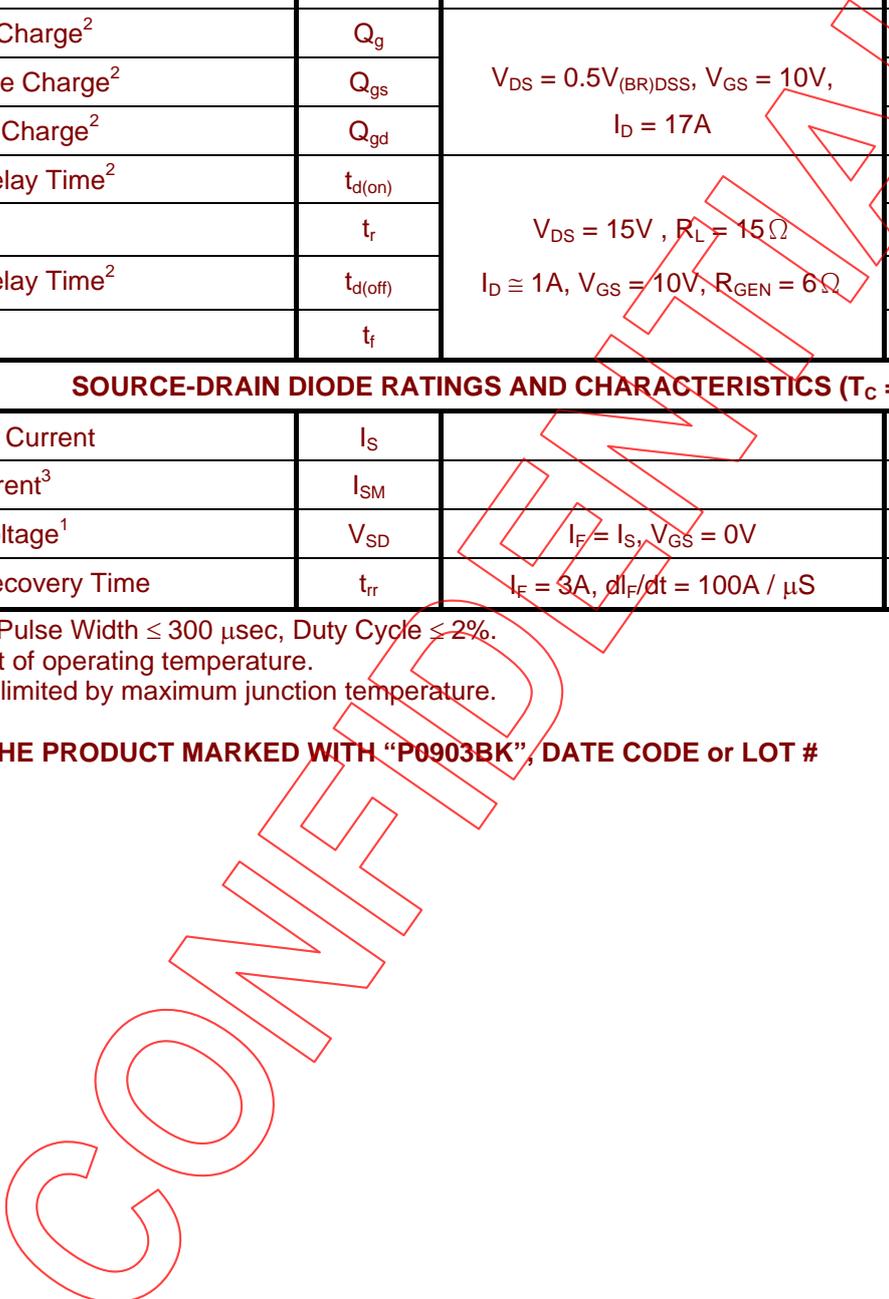
DYNAMIC					
Input Capacitance	C_{iss}	$V_{GS} = 0V, V_{DS} = 15V, f = 1MHz$		2700	
Output Capacitance	C_{oss}			620	pF
Reverse Transfer Capacitance	C_{rss}			210	
Total Gate Charge ²	Q_g	$V_{DS} = 0.5V_{(BR)DSS}, V_{GS} = 10V,$ $I_D = 17A$		21	30
Gate-Source Charge ²	Q_{gs}			8	nC
Gate-Drain Charge ²	Q_{gd}			7.2	
Turn-On Delay Time ²	$t_{d(on)}$	$V_{DS} = 15V, R_L = 15\Omega$ $I_D \cong 1A, V_{GS} = 10V, R_{GEN} = 6\Omega$		16	
Rise Time ²	t_r			25	nS
Turn-Off Delay Time ²	$t_{d(off)}$			60	
Fall Time ²	t_f			16	
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ($T_C = 25^\circ C$)					
Continuous Current	I_S			4.5	A
Pulsed Current ³	I_{SM}			9	
Forward Voltage ¹	V_{SD}	$I_F = I_S, V_{GS} = 0V$		1.1	V
Reverse Recovery Time	t_{rr}	$I_F = 3A, di_F/dt = 100A / \mu S$		40	70 nS

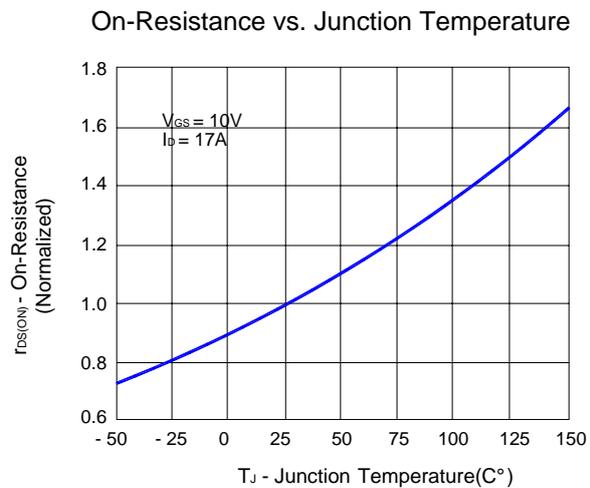
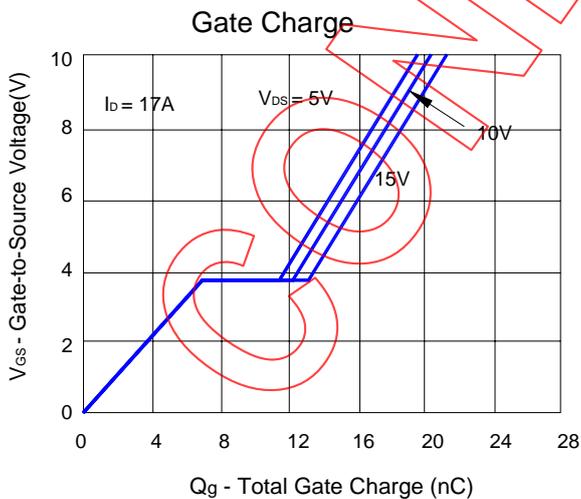
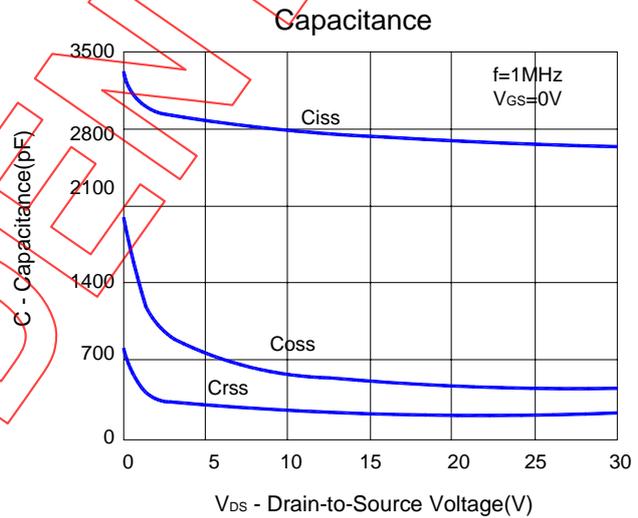
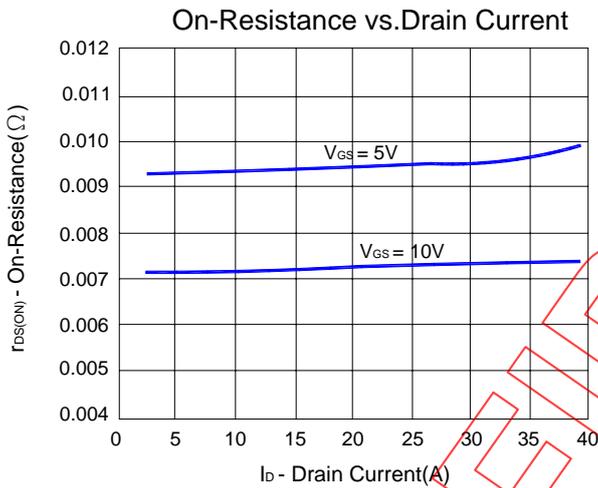
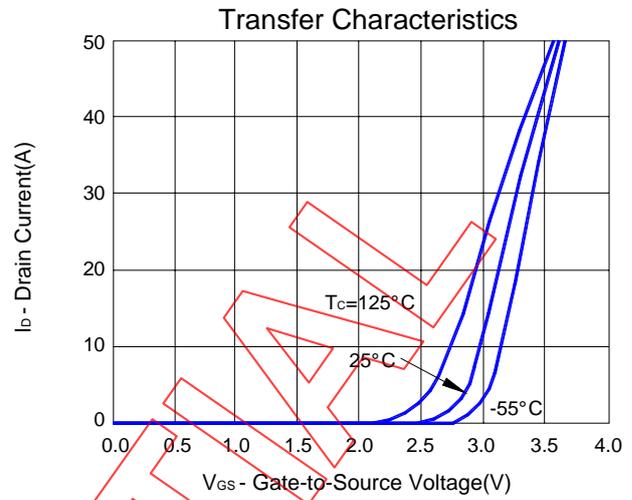
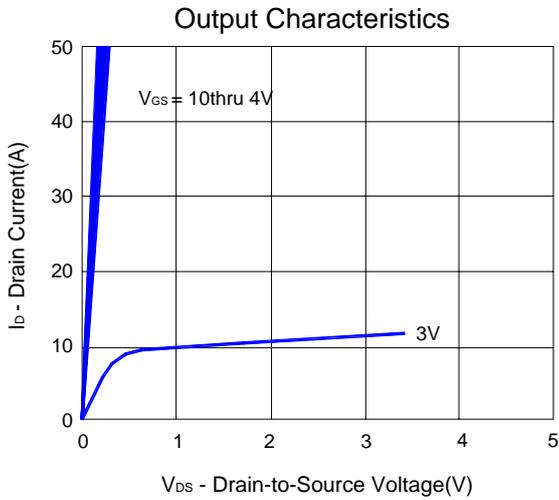
¹Pulse test : Pulse Width $\leq 300 \mu sec$, Duty Cycle $\leq 2\%$.

²Independent of operating temperature.

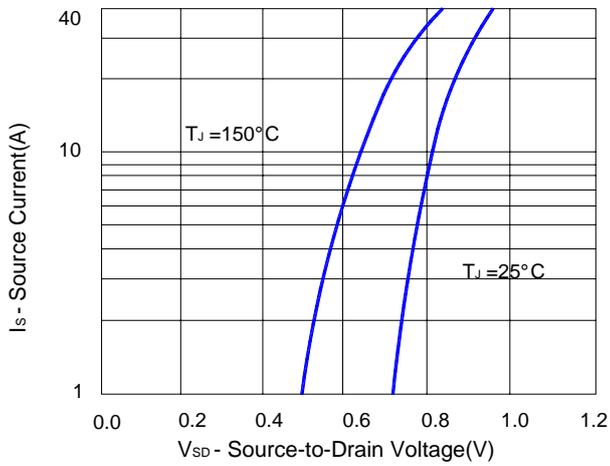
³Pulse width limited by maximum junction temperature.

REMARK: THE PRODUCT MARKED WITH "P0903BK", DATE CODE or LOT #

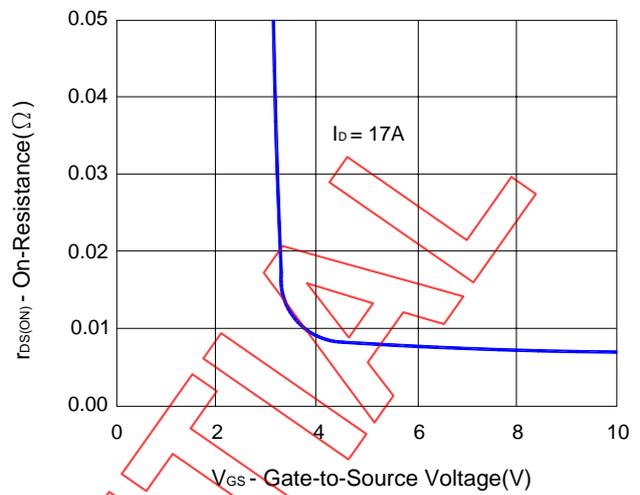




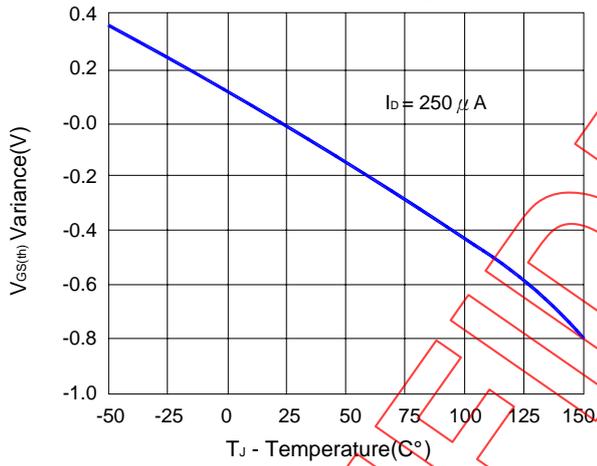
Source - Drain Diode Forward Voltage



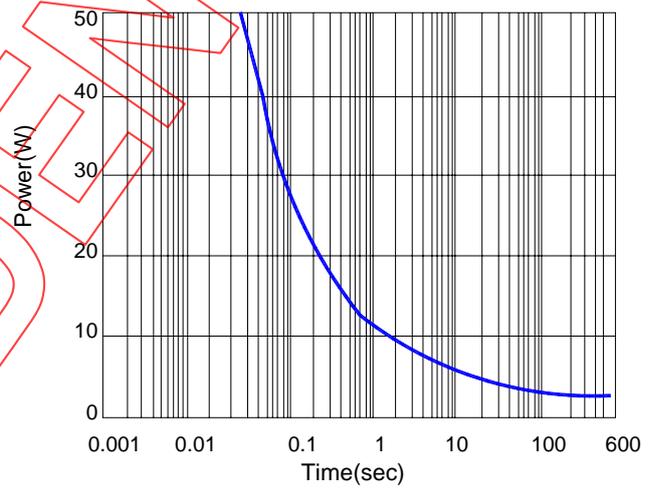
On-Resistance vs. Gate-to-Source Voltage



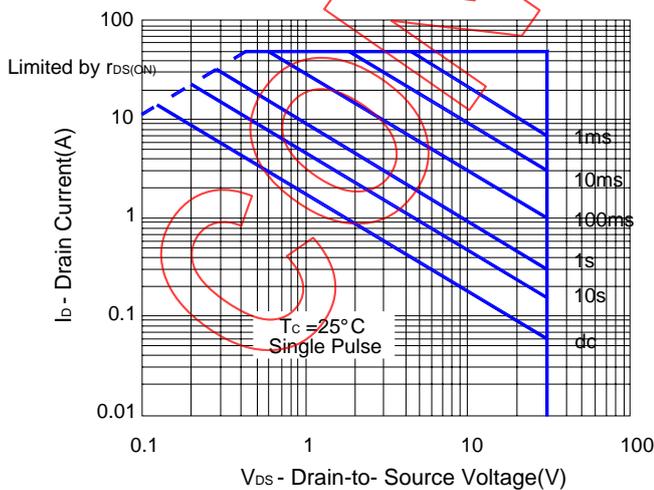
Threshold Voltage



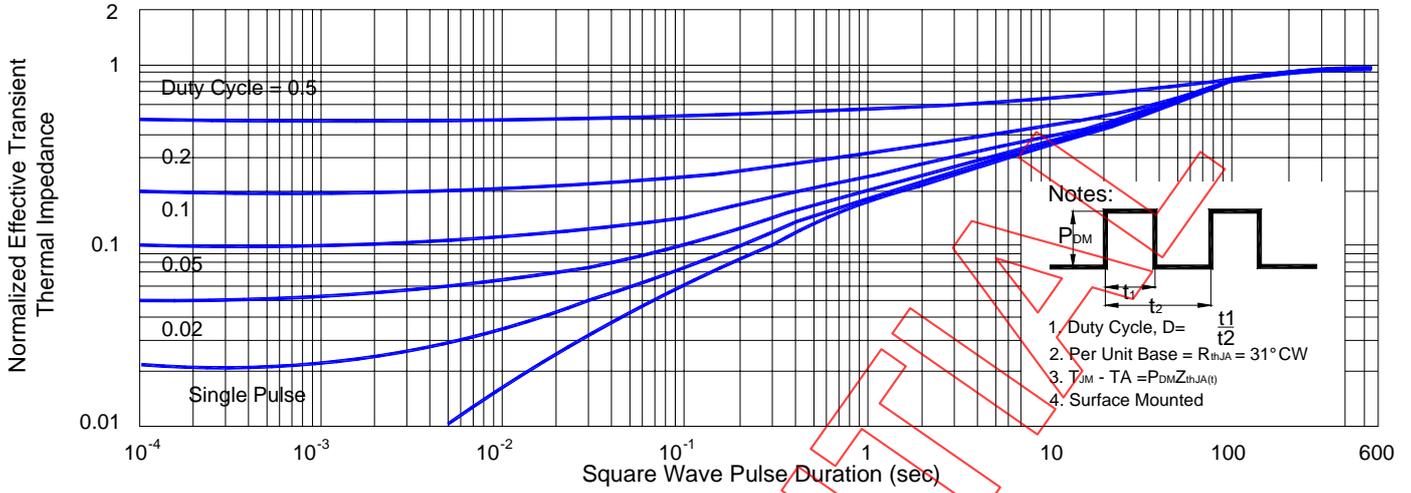
Single Pulse Power



Safe Operating Area, Junction-to-Case



Normalized Thermal Transient Impedance, Junction-to-Ambient



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NPAK SOP-8 MECHANICAL DATA

Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	4.8	4.9	5.0	H	3.67	3.87	4.02
B	5.7	5.75	5.8	I	0.41	0.51	0.61
C	5.9	6.0	6.1	J	3.38	3.58	3.78
D	0.33	0.41	0.51	K	1.1		
E		1.27		L	0.51	0.61	0.71
F	0.9	1.0	1.1	M	0°		12°
G	0.2	0.25	0.3	N			

